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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Walter SCHWARZENBACH et al.

Confirmation No.: 3337

Application No.:

10/766,207

Group Art Unit: 2822

Filing Date:

January 29, 2004

Examiner: Khanh B. Duong

Attorney Docket No.: 4717-11600

METHOD OF DETACHING A LAYER FROM A

WAFER USING A LOCALIZED **STARTING** 

AREA

## **AMENDMENT**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed September 20, 2005 and the Notice dated December 6, 2005, Applicants respectfully request entry of the following amendments and remarks into the file of this application.

Amendments to the Specification appear on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 6 of this paper.

No fee is believed to be due for the claim changes and additions of this submission. Please charge any and all required fees to Winston & Strawn LLP Deposit Account No. 50-1814.